

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

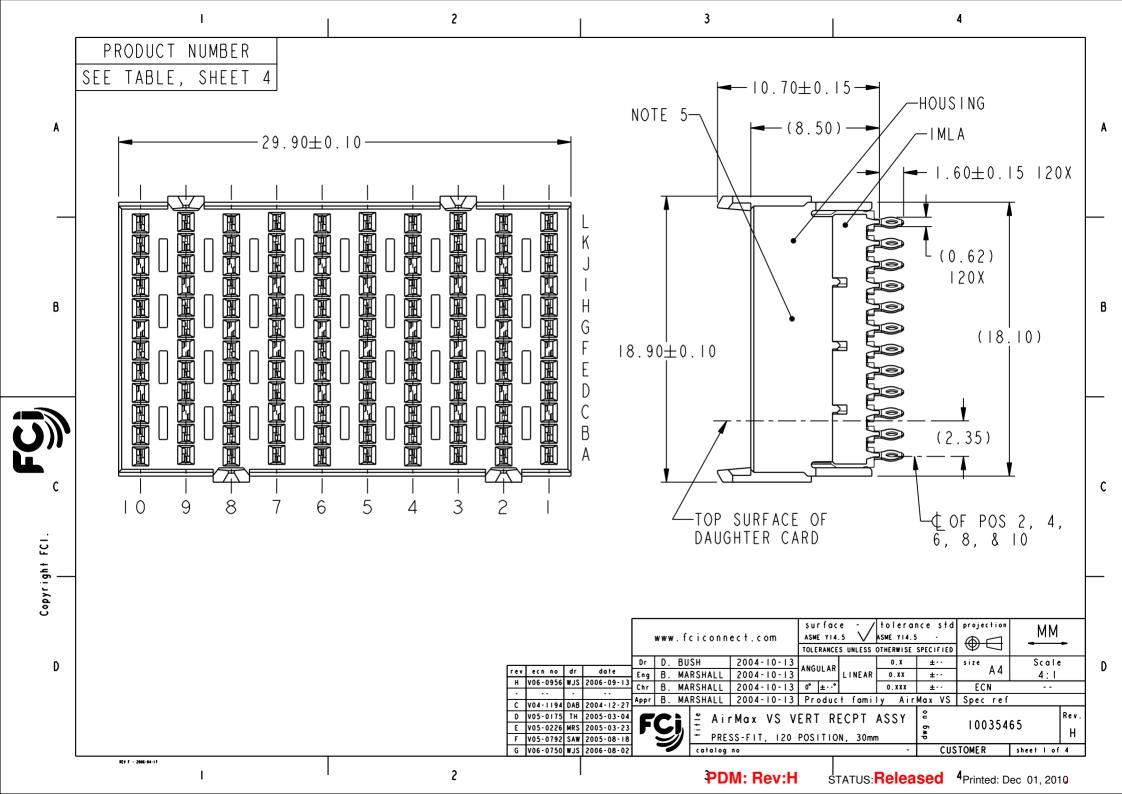
Email & Skype: info@chipsmall.com Web: www.chipsmall.com

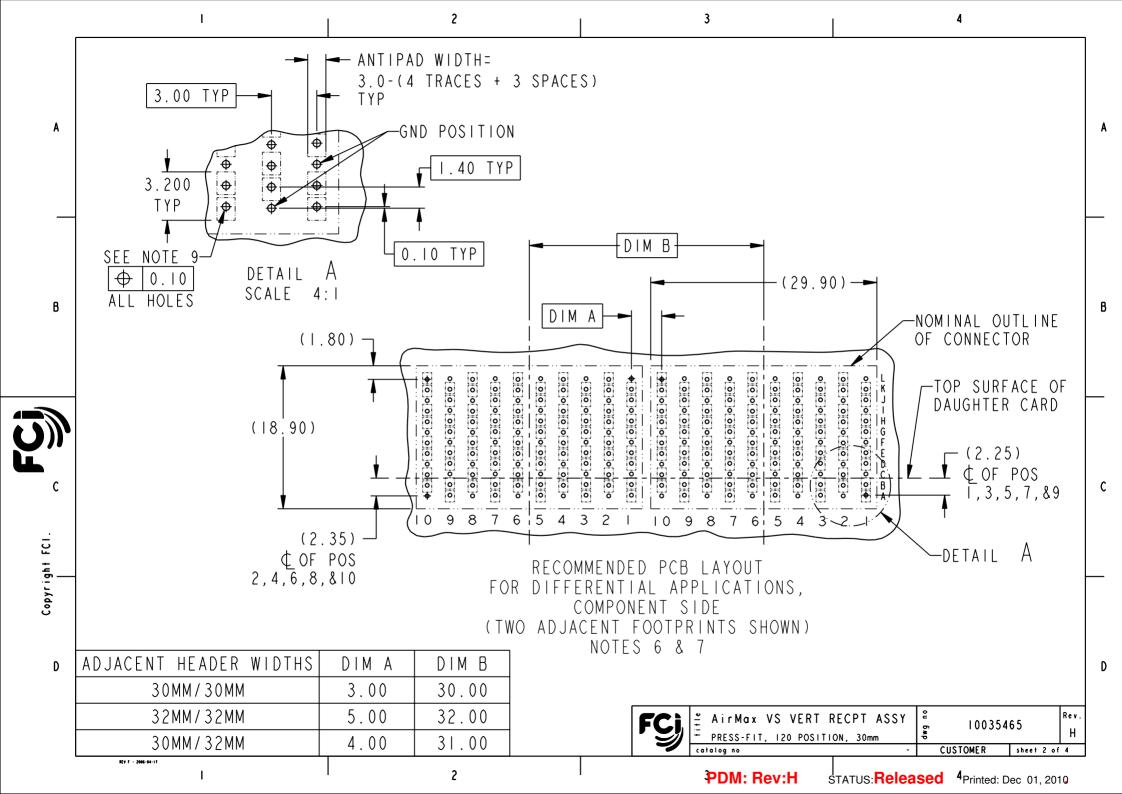
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

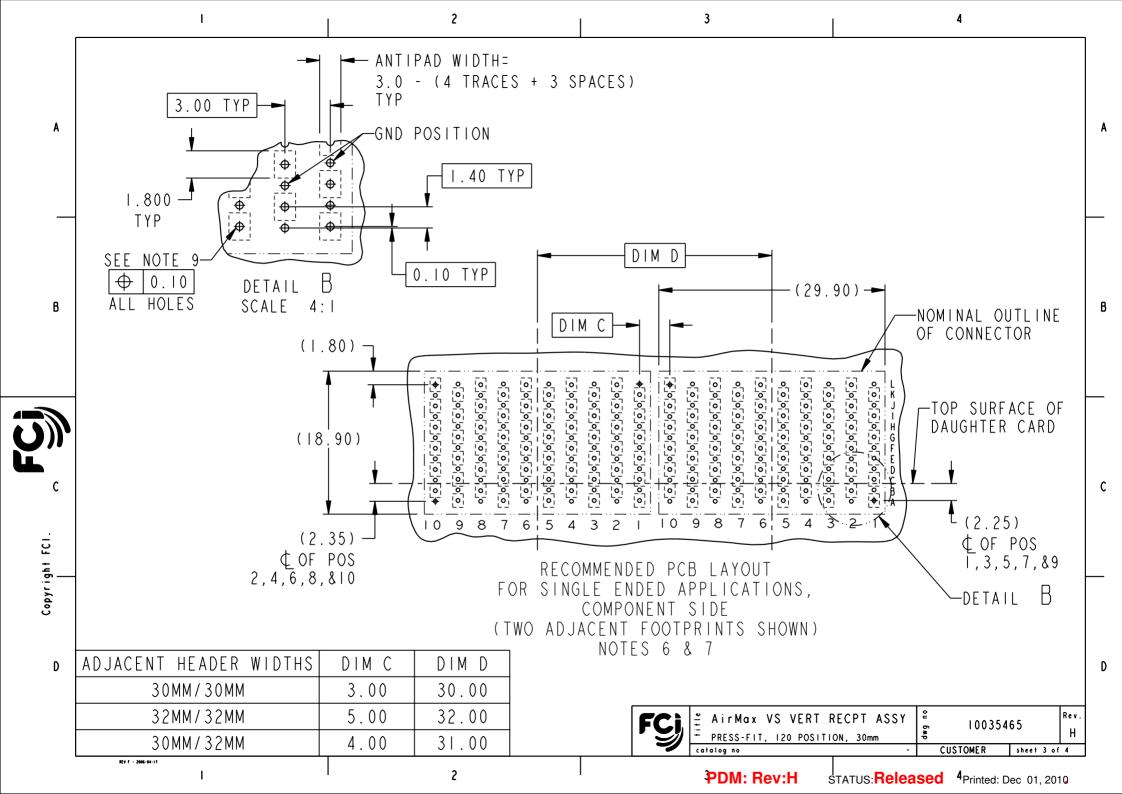












NOTES:

CONNECTOR MATERIALS:

HOUSING & RETAINER: HIGH TEMP THERMOPLASTIC. NATURAL. UL94V-0 IMLA PLASTIC: HIGH TEMP THERMOPLASTIC. BLACK. UL94V-0 CONTACT: COPPER ALLOY

2. CONTACT PLATING:

SEPARABLE INTERFACE:

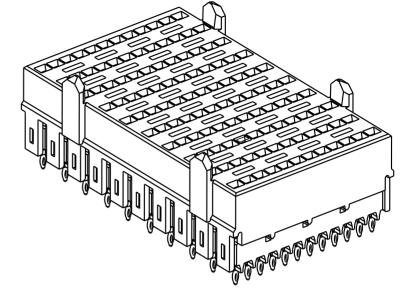
PERFORMANCE-BASED PLATING, QUALIFIED TO MEET THE REQUIREMENTS OF FCI PRODUCT SPECIFICATION GS-12-239. INCLUDING TELCORDIA GR-1217-CORE (NOVEMBER 1995) CENTRAL OFFICE

PRESS-FIT TAILS: SEE TABLE

3. PRODUCT SPECIFICATION: GS-12-239

4. APPLICATION SPECIFICATION: GS-20-035

- PRODUCT MARKING. (PART NUMBER & LOT CODE). ON THIS SURFACE
- 6.)REFER TO CUSTOMER DRAWING 10035911 FOR INFORMATION REGARDING PCB LAYOUT OF POWER AND GUIDE MODULES RELATIVE TO SIGNAL MODULES
- POSITIONS F OF ODD NUMBERED COLUMNS AND POSITIONS G OF EVEN NUMBERED COLUMNS CORRESPOND TO EARLY MATE HEADER PINS
- 8. THERE IS NO GROUND BUSSING WITHIN THE CONNECTOR SYSTEM
- REFER TO CUSTOMER DRAWING 10045979 FOR INFORMATION ON PCB HOLE DIAMETERS AND PLATING OPTIONS.
- IO. THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008.



II. THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 40 SECONDS IN A CONVECTION. INFRA-RED OR VAPOR PHASE REFLOW OVEN.

12. PACKAGING MEETS GS-14-920 LEAD FREE LABELING SPECIFICATION.

AirMax VS VERT RECPT ASSY PRESS-FIT, 120 POSITION, 30mm

10035465

CUSTOMER sheet 4 of 4

Rev.

PDM: Rev:H

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